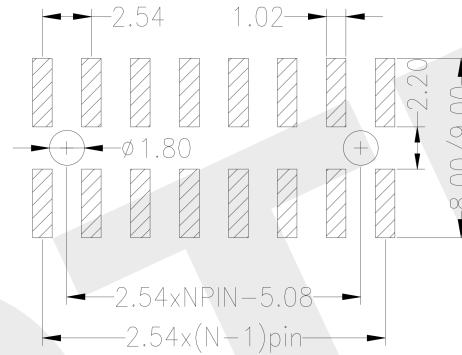
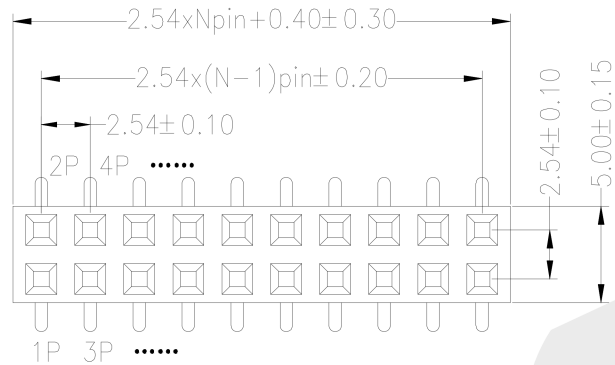
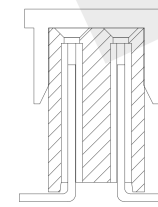
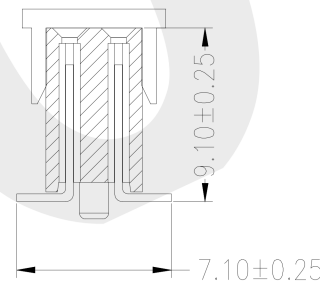
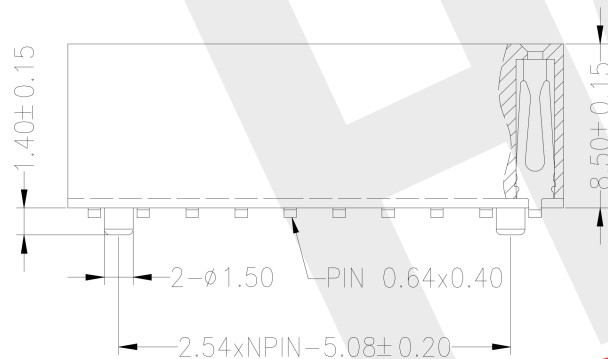
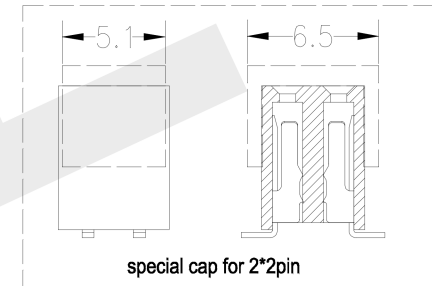


Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)



SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20m Ω Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000M Ω Min
Operation Temperature:-40°C to +105°C

Contact Material:Copper Alloy
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 260°C $\pm 5^\circ\text{C}$ 5S



P = With Post

默认 = W/O Post

Ordering Information

PM 254 - * - N - S - * - * - * - P

No. of Rows 1=Single Row 2=Dual Row	No. of Pins 2-40Pin	Type 2=直插 3=贴片 4=贴片	Length (mm) 排母	Contact Plating G0:Gold Flash G1:1u" Gold G2:3u" Gold G3:5u" Gold G4:10u" Gold G5:15u" Gold G6:30u" Gold S0:Gold Flash/Tin S1:Tin	Packing R=Reel +Cap (需+盖)	Post (带孔)
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GENERAL TOLERANCE		制图 DRAWING	深圳市华灿天禄电子有限公司 ShenzhenhuacantianluELECTRONICS CO., LTD	
DIM	TOL	审核 CHECK	产品名称 TITLE	版本 REV.
X.X	± 0.30	批准 APPROVAL	2.54双排 贴片 编带+盖 带柱(塑高8.5)	A
X.XX	± 0.20	比例 SCALE	产品料号 PART NO.	单位 UNITS
X.XXX	± 0.10	投影 Projection	PM254-2-N-S-8.5-XX-R-P	页次 SHEET
Angle	$\pm 3.0^\circ$		材料 MATERIAL	1/1